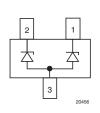


Two-Line ESD Protection in SOT-23





MARKING (example only)



YYY = type code (see table below) XX = date code

DESIGN SUPPORT TOOLS AVAILABLE





FEATURES

- Two-line ESD protection device
- ESD immunity acc. IEC 61000-4-2
 - ± 30 kV contact discharge
 - ± 30 kV air discharge
- ESD capability according to AEC-Q101: human body model: class H3B: > 8 kV
- Space saving SOT-23 package
- e3 Sn
- AEC-Q101 qualified available







ROHS
COMPLIANT
HALOGEN
FREE
Available

GREEN (5-2008)

ORDERIN	ORDERING INFORMATION							
	ENVIR	ONMENTAL AN	ID QUALITY CO	DDE	PACKAG	ING CODE		
PART NUMBER (EXAMPLE)	AEC-Q101	RoHS-COM LEAD (P	MPLIANT + b)-FREE	TIN	3K PER 7" REEL (8 mm TAPE),	10K PER 13" REEL (8 mm TAPE),	ORDERING CODE (EXAMPLE)	
(EXAMILE)	XAMPLE) QUALIFIED STANDARD GREEN PLATED 15	15K/BOX = MÓQ	10K/BOX = MÓQ					
GSOT05C-		Е		3	-08		GSOT05C-E3-08	
GSOT05C-			G	3	-08		GSOT05C-G3-08	
GSOT05C-	Н	E		3	-08		GSOT05C-HE3-08	
GSOT05C-	Н		G	3	-08		GSOT05C-HG3-08	
GSOT05C-		E		3		-18	GSOT05C-E3-18	
GSOT05C-			G	3		-18	GSOT05C-G3-18	
GSOT05C-	Н	E		3		-18	GSOT05C-HE3-18	
GSOT05C-	Н		G	3		-18	GSOT05C-HG3-18	

PACKAG	PACKAGE DATA						
DEVICE NAME	PACKAGE NAME	TYPE CODE	ENVIRONMENTAL STATUS	WEIGHT	MOLDING COMPOUND FLAMMABILITY RATING	MOISTURE SENSITIVITY LEVEL	SOLDERING CONDITIONS
GSOT03C	SOT-23	03C	Standard	8.8 mg	UL 94 V-0	MSL level 1	Peak temperature
		C1G	Green	8.1 mg		(according J-STD-020)	max. 260 °C
GSOT04C	SOT-23	04C	Standard	8.8 mg	UL 94 V-0	MSL level 1	Peak temperature
4301040	301-23	C8G	Green	8.1 mg	OL 34 V-0	(according J-STD-020)	max. 260 °C
GSOT05C	SOT-23	05C	Standard	8.8 mg	UL 94 V-0	MSL level 1	Peak temperature
GSOTOSC	301-23	C2G	Green	8.1 mg	OL 94 V-0	(according J-STD-020)	max. 260 °C
GSOT08C	SOT-23	08C	Standard	8.8 mg	UL 94 V-0	MSL level 1	Peak temperature
G30106C	301-23	C3G	Green	8.1 mg	OL 94 V-0	(according J-STD-020)	max. 260 °C
GSOT12C	SOT-23	12C	Standard	8.8 mg	UL 94 V-0	MSL level 1	Peak temperature
G301120	301-23	C4G	Green	8.1 mg	OL 94 V-0	(according J-STD-020)	max. 260 °C
GSOT15C	SOT-23	15C	Standard	8.8 mg	UL 94 V-0	MSL level 1	Peak temperature
GSOTISC	301-23	C5G	Green	8.1 mg	OL 94 V-0	(according J-STD-020)	max. 260 °C
GSOT24C	SOT-23	24C	Standard	8.8 mg	UL 94 V-0	MSL level 1	Peak temperature
G301240	301-23	C6G	Green	8.1 mg	UL 94 V-0	(according J-STD-020)	max. 260 °C
GSOT36C	SOT-23	36C	Standard	8.8 mg	UL 94 V-0	MSL level 1	Peak temperature
G301300	301-23	C7G	Green	8.1 mg	OL 34 V-0	(according J-STD-020)	max. 260 °C

Rev. 2.9, 17-Apr-2019 **1** Document Number: 85824



ABSOLUTE MAXIMUM RATINGS GSOT03C						
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT		
Post of law or work	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, t _p = 8/20 μs; single shot	I	30	А		
Peak pulse current	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \mu s$; single shot	* ·	30	Α		
	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, t _p = 8/20 μs; single shot	D	369	W		
Peak pulse power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \mu s$; single shot	P _{PP}	504	W		
CCD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	M	± 30	kV		
ESD immunity	Air discharge acc. IEC 61000-4-2; 10 pulses	V_{ESD}	± 30	kV		
Operating temperature	Junction temperature	TJ	-55 to +150	°C		
Storage temperature		T _{STG}	-55 to +150	°C		

ABSOLUTE MAXIMUM RATINGS GSOT04C						
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT		
Peak pulse current	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \mu s$; single shot	l	30	А		
	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \mu s$; single shot	ІРРМ	30	Α		
B	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \mu s$; single shot	P _{PP}	429	W		
Peak pulse power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \mu s$; single shot	ГРР	564	W		
CCD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V	± 30	kV		
ESD immunity	Air discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV		
Operating temperature	Junction temperature	TJ	-55 to +150	°C		
Storage temperature		T _{STG}	-55 to +150	°C		

ABSOLUTE MAXIMUM RATINGS GSOT05C						
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT		
Post of the count	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \mu s$; single shot	I	30	А		
Peak pulse current	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \mu s$; single shot	ІРРМ	30	Α		
B	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \mu s$; single shot	P _{PP}	480	W		
Peak pulse power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \mu s$; single shot	ГРР	612	W		
ECD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	W	± 30	kV		
ESD immunity	Air discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV		
Operating temperature	Junction temperature	T _J	-55 to +150	°C		
Storage temperature		T _{STG}	-55 to +150	°C		



ABSOLUTE MAXIMUM RATINGS GSOT08C						
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT		
Deals autonomist	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \mu s$; single shot	I	18	Α		
Peak pulse current	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \mu s$; single shot	ІРРМ	18	А		
	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \mu s$; single shot	P _{PP}	345	W		
Peak pulse power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, t _p = 8/20 µs; single shot	ГРР	400	W		
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V	± 30	kV		
ESD IIIIIIdriity	Air discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV		
Operating temperature	Junction temperature	T_J	-55 to +150	°C		
Storage temperature		T _{STG}	-55 to +150	°C		

ABSOLUTE MAXIMUM RATINGS GSOT12C					
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT	
Bartantan	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \mu s$; single shot	I	12	А	
Peak pulse current	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \mu s$; single shot	I _{PPM}	12	Α	
Peak pulse power	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \mu s$; single shot	P_PP	312	W	
reak puise power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \mu s$; single shot	ГРР	337	W	
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	W	± 30	kV	
ESD IIIIIIuriity	Air discharge acc. IEC 61000-4-2; 10 pulses	V_{ESD}	± 30	kV	
Operating temperature	Junction temperature	T _J	-55 to +150	°C	
Storage temperature		T _{STG}	-55 to +150	°C	

ABSOLUTE MAXIMUM RATINGS GSOT15C						
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT		
Peak pulse current	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \mu s$; single shot	l	8	Α		
	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, t_p = 8/20 μ s; single shot	ІРРМ	8	Α		
	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \mu s$; single shot	D	345	W		
Peak pulse power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \mu s$; single shot	P _{PP}	400	W		
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V	± 30	kV		
ESD initiduity	Air discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV		
Operating temperature	Junction temperature	TJ	-55 to +150	°C		
Storage temperature		T _{STG}	-55 to +150	°C		



ABSOLUTE MAXIMUM RATINGS GSOT24C					
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT	
Peak pulse current	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \mu s$; single shot	Іррм	5	А	
	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \mu s$; single shot	ТРРМ	5	Α	
Peak pulse power	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \mu s$; single shot	P _{PP}	235	W	
reak puise power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, $t_p = 8/20 \mu s$; single shot	ГРР	240	W	
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV	
LSD infiniting	Air discharge acc. IEC 61000-4-2; 10 pulses	VESD	± 30	kV	
Operating temperature	Junction temperature	TJ	-55 to +150	°C	
Storage temperature		T _{STG}	-55 to +150	°C	

ABSOLUTE MAXIMUM RATINGS GSOT36C					
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT	
Peak pulse current	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \mu s$; single shot	lan	3.5	А	
r ear puise current	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, t_p = 8/20 μ s; single shot		3.5	Α	
Deal of land of	Pin 1 to 3 or pin 2 to 3 acc. IEC 61000-4-5, $t_p = 8/20 \mu s$; single shot	P _{PP}	248	W	
Peak pulse power	Pin 1 to 2 or pin 2 to 1; pin 3 not connected acc. IEC 61000-4-5, t_p = 8/20 μ s; single shot	- грр	252	W	
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V _{ESD}	± 30	kV	
ESD inimunity	Air discharge acc. IEC 61000-4-2; 10 pulses	VESD	± 30	kV	
Operating temperature	Junction temperature	T _J	-55 to +150	°C	
Storage temperature		T _{STG}	-55 to +150	°C	



www.vishay.com

Vishay Semiconductors

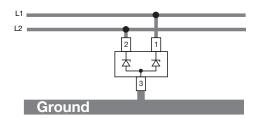
BIAs-MODE (2-line Bidirectional Asymmetrical protection mode)

With the GSOTxxC two signal- or data-lines (L1, L2) can be protected against voltage transients. With pin 3 connected to ground and pin 1 and pin 2 connected to a signal- or data-line which has to be protected. As long as the voltage level on the data- or signal-line is between 0 V (ground level) and the specified Maximum Reverse Working Voltage (V_{RWM}) the protection diode between pin 2 and pin 3 and between pin 1 and pin 3 offers a high isolation to the ground line. The protection device behaves like an open switch.

As soon as any positive transient voltage signal exceeds the breakdown voltage level of the protection diode, the diode becomes conductive and shorts the transient current to ground. Now the protection device behaves like a closed switch. The Clamping Voltage (V_C) is defined by the breakdown voltage (V_{BR}) level plus the voltage drop at the series impedance (resistance and inductance) of the protection diode.

Any negative transient signal will be clamped accordingly. The negative transient current is flowing in the forward direction through the protection diode. The low Forward Voltage (V_F) clamps the negative transient close to the ground level.

Due to the different clamping levels in forward and reverse direction the GSOTxxC clamping behavior is Bidirectional and Asymmetrical (BiAs).

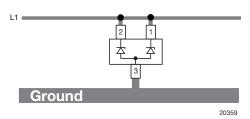




If a higher surge current or peak pulse current (I_{PP}) is needed, both protection diodes in the GSOTxxC can also be used in parallel in order to "double" the performance.

This offers:

- double surge power = double peak pulse current (2 x I_{PPM})
- half of the line inductance = reduced clamping voltage
- half of the line resistance = reduced clamping voltage
- double line capacitance (2 x C_D)
- double reverse leakage current (2 x I_R)



ELECTRICAL CHARACTERISTICS GSOT03C (T _{amb} = 25 °C unless otherwise specified) between pin 1 to pin 3 or pin 2 to pin 3							
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Protection paths	Number of lines which can be protected	N _{channel}	-	-	2	lines	
Reverse stand-off voltage	Max. reverse working voltage	V_{RWM}	-	-	3.3	V	
Reverse voltage	at I _R = 100 μA	V_R	3.3	-	-	V	
Reverse current	at V _R = 3.3 V	I _R	-	-	100	μΑ	
Reverse breakdown voltage	at I _R = 1 mA	V_{BR}	4.0	4.6	5.5	V	
Deverse elemning voltage	at I _{PP} = 1 A	V	-	5.7	7.5	V	
Reverse clamping voltage	at I _{PP} = I _{PPM} = 30 A	V _C	-	10	12.3	V	
Converd elemping veltage	at I _{PP} = 1 A	V	-	1	1.2	V	
Forward clamping voltage	at I _{PP} = I _{PPM} = 30 A	V _F	-	4.5	-	V	
Canaditanas	at V _R = 0 V; f = 1 MHz		-	420	600	pF	
Capacitance	at V _R = 1.6 V; f = 1 MHz	C_D	-	260	-	pF	



ELECTRICAL CHARACTERISTICS GSOT04C (T _{amb} = 25 °C unless otherwise specified) between pin 1 to pin 3 or pin 2 to pin 3							
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Protection paths	Number of lines which can be protected	N _{channel}	-	-	2	lines	
Reverse stand-off voltage	Max. reverse working voltage	V_{RWM}	-	-	4	V	
Reverse voltage	at I _R = 20 μA	V_R	4	-	-	V	
Reverse current	at V _R = 4 V	I _R	-	-	20	μΑ	
Reverse breakdown voltage	at I _R = 1 mA	V_{BR}	5	6.1	7	V	
Deverse elements voltage	at I _{PP} = 1 A		-	7.5	9	V	
Reverse clamping voltage	at I _{PP} = I _{PPM} = 30 A	V _C	-	11.2	14.3	V	
Famoured alarmatic acceptance	at I _{PP} = 1 A	.,,	-	1	1.2	V	
Forward clamping voltage	at I _{PP} = I _{PPM} = 30 A	V _F	-	4.5	-	V	
Canacitanas	at V _R = 0 V; f = 1 MHz		-	310	450	pF	
Capacitance	at V _R = 2 V; f = 1 MHz	C _D	-	200	-	pF	

ELECTRICAL CHARACTERISTICS GSOT05C (T _{amb} = 25 °C unless otherwise specified) between pin 1 to pin 3 or pin 2 to pin 3								
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Protection paths	Number of lines which can be protected	N _{channel}	-	-	2	lines		
Reverse stand-off voltage	Max. reverse working voltage	V_{RWM}	-	-	5	V		
Reverse voltage	at I _R = 10 μA	V_R	5	-	-	V		
Reverse current	at V _R = 5 V	I _R	-	-	10	μA		
Reverse breakdown voltage	at I _R = 1 mA	V_{BR}	6	6.8	8	V		
Deverse elemning veltage	at I _{PP} = 1 A	V	-	7	8.7	V		
Reverse clamping voltage	at I _{PP} = I _{PPM} = 30 A	V _C	-	12	16	V		
Command alamanian valtana	at I _{PP} = 1 A	V	-	1	1.2	V		
Forward clamping voltage	at I _{PP} = I _{PPM} = 30 A	V _F	-	4.5	-	V		
Canacitanas	at V _R = 0 V; f = 1 MHz	- C _D	-	260	350	pF		
Capacitance	at V _R = 2.5 V; f = 1 MHz		-	150	-	pF		

ELECTRICAL CHARACTERISTICS GSOT08C (T _{amb} = 25 °C unless otherwise specified) between pin 1 to pin 3 or pin 2 to pin 3								
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Protection paths	Number of lines which can be protected	N _{channel}	-	-	2	lines		
Reverse stand-off voltage	Max. reverse working voltage	V_{RWM}	-	-	8	V		
Reverse voltage	at I _R = 5 μA	V_R	8	-	-	V		
Reverse current	at V _R = 8 V	I _R	-	-	5	μA		
Reverse breakdown voltage	at I _R = 1 mA	V_{BR}	9	10	11	V		
Deverse elemning veltage	at I _{PP} = 1 A	V	-	10.7	13	V		
Reverse clamping voltage	at I _{PP} = I _{PPM} = 18 A	V _C	-	15.2	19.2	V		
Conveyed alarmains valtage	at I _{PP} = 1 A	M	-	1	1.2	V		
Forward clamping voltage	at I _{PP} = I _{PPM} = 18 A	V _F	-	3	-	V		
Canaditanas	at V _R = 0 V; f = 1 MHz		-	160	250	pF		
Capacitance	at V _R = 4 V; f = 1 MHz	C _D	-	80	-	pF		



ELECTRICAL CHARACTERISTICS GSOT12C (T _{amb} = 25 °C unless otherwise specified) between pin 1 to pin 3 or pin 2 to pin 3									
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT			
Protection paths	Number of lines which can be protected	N _{channel}	-	-	2	lines			
Reverse stand-off voltage	Max. reverse working voltage	V_{RWM}	-	-	12	V			
Reverse voltage	at I _R = 1 μA	V_R	12	-	-	V			
Reverse current	at V _R = 12 V	I _R	-	-	1	μΑ			
Reverse breakdown voltage	at I _R = 1 mA	V_{BR}	13.5	15	16.5	V			
Poverse elemping voltage	at I _{PP} = 1 A	V	-	15.4	18.7	V			
Reverse clamping voltage	at I _{PP} = I _{PPM} = 12 A	V _C	-	21.2	26	V			
Famusard alamaning valtage	at I _{PP} = 1 A	V	-	1	1.2	V			
Forward clamping voltage	at I _{PP} = I _{PPM} = 12 A	V _F	-	2.2	-	V			
Conscitores	at V _R = 0 V; f = 1 MHz	C _D	-	115	150	pF			
Capacitance	at V _R = 6 V; f = 1 MHz		-	50	-	pF			

ELECTRICAL CHARACTERISTICS GSOT15C (T _{amb} = 25 °C unless otherwise specified) between pin 1 to pin 3 or pin 2 to pin 3								
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Protection paths	Number of lines which can be protected	N _{channel}	-	-	2	lines		
Reverse stand-off voltage	Max. reverse working voltage	V_{RWM}	-	-	15	V		
Reverse voltage	at I _R = 1 μA	V_R	15	-	-	V		
Reverse current	at V _R = 15 V	I _R	-	-	1	μΑ		
Reverse breakdown voltage	at I _R = 1 mA	V_{BR}	16.5	18	20	V		
Deverse elemning veltage	at I _{PP} = 1 A	V	-	19.4	23.5	V		
Reverse clamping voltage	at I _{PP} = I _{PPM} = 8 A	V _C	-	24.8	28.8	V		
Forward clamping voltage	at I _{PP} = 1 A	W	-	1	1.2	V		
Forward clamping voltage	at I _{PP} = I _{PPM} = 8 A	V _F	-	1.8	-	V		
Canacitanas	at V _R = 0 V; f = 1 MHz	- C _D	-	90	120	pF		
Capacitance	at V _R = 7.5 V; f = 1 MHz		-	35	-	pF		

ELECTRICAL CHARACTERISTICS GSOT24C (T _{amb} = 25 °C unless otherwise specified) between pin 1 to pin 3 or pin 2 to pin 3								
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Protection paths	Number of lines which can be protected	N _{channel}	-	-	2	lines		
Reverse stand-off voltage	Max. reverse working voltage	V_{RWM}	-	-	24	V		
Reverse voltage	at I _R = 1 μA	V_R	24	-	-	V		
Reverse current	at V _R = 24 V	I _R	-	-	1	μΑ		
Reverse breakdown voltage	at I _R = 1 mA	V_{BR}	27	30	33	V		
Deverse elemning veltage	at I _{PP} = 1 A	V	-	34	41	V		
Reverse clamping voltage	at I _{PP} = I _{PPM} = 5 A	V _C	-	41	47	V		
Farmer department and the second	at I _{PP} = 1 A	V	-	1	1.2	V		
Forward clamping voltage	at I _{PP} = I _{PPM} = 5 A	V _F	-	1.4	-	V		
Oit	at V _R = 0 V; f = 1 MHz	_	-	65	80	pF		
Capacitance	at V _R = 12 V; f = 1 MHz	C_D	-	20	-	pF		

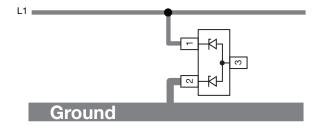


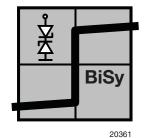
ELECTRICAL CHARACTERISTICS GSOT36C (T _{amb} = 25 °C unless otherwise specified) between pin 1 to pin 3 or pin 2 to pin 3								
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Protection paths	Number of lines which can be protected	N _{channel}	-	-	2	lines		
Reverse stand-off voltage	Max. reverse working voltage	V_{RWM}	-	-	36	V		
Reverse voltage	at I _R = 1 μA	V_R	36	-	-	V		
Reverse current	at V _R = 36 V	I _R	-	-	1	μΑ		
Reverse breakdown voltage	at I _R = 1 mA	V_{BR}	39	43	47	V		
Deverse elements veltage	at I _{PP} = 1 A	V	-	49	60	V		
Reverse clamping voltage	at I _{PP} = I _{PPM} = 3.5 A	V _C	-	59	71	V		
Converd elements veltage	at I _{PP} = 1 A	V	-	1	1.2	V		
Forward clamping voltage	at I _{PP} = I _{PPM} = 3.5 A	V _F	-	1.3	-	V		
Canacitanas	at V _R = 0 V; f = 1 MHz	- C _D	-	52	65	pF		
Capacitance	at V _R = 18 V; f = 1 MHz		-	12	-	pF		

BISy-MODE (1-line bidirectional symmetrical protection mode)

If a bipolar symmetrical protection device is needed the GSOTxxC can also be used as a single line protection device. Therefore pin 1 has to be connected to the signal- or data-line (L1) and pin 2 to ground (or vice versa). Pin 3 must not be connected. Positive and negative voltage transients will be clamped in the same way. The clamping current through the GSOTxxC passes one diode in forward direction and the other one in reverse direction. The clamping voltage (V_C) is defined by the breakthrough voltage (V_B) level of one diode plus the forward voltage of the other diode plus the voltage drop at the series impedances (resistances and inductances) of the protection device.

Due to the same clamping levels in positive and negative direction the GSOTxxC voltage clamping behaviour is bidirectional and symmetrical (BiSy).





ELECTRICAL CHARACTERISTICS GSOT03C (T _{amb} = 25 °C unless otherwise specified) between pin 1 to pin 2 or pin 2 to pin1; pin 3 not connected								
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Protection paths	Number of lines which can be protected	N _{channel}	-	-	1	lines		
Reverse stand-off voltage	Max. reverse working voltage	V_{RWM}	-	-	3.8	V		
Reverse voltage	at I _R = 100 μA	V_R	3.8	-	-	V		
Reverse current	at V _R = 3.8 V	I _R	-	-	100	μΑ		
Reverse breakdown voltage	at I _R = 1 mA	V_{BR}	4.5	5.3	6.2	V		
Develope algorithm with the	at I _{PP} = 1 A	V	-	7	8.4	V		
Reverse clamping voltage	at I _{PP} = I _{PPM} = 30 A	V _C	-	14	16.8	V		
Capacitance	at V _R = 0 V; f = 1 MHz		-	210	300	pF		
	at V _P = 1.6 V: f = 1 MHz	C _D	-	190	_	рF		



ELECTRICAL CHARACTERISTICS GSOT04C (T _{amb} = 25 °C unless otherwise specified) between pin 1 to pin 2 or pin 2 to pin1; pin 3 not connected								
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Protection paths	Number of lines which can be protected	N _{channel}	1	-	1	lines		
Reverse stand-off voltage	Max. reverse working voltage	V_{RWM}	-	-	4.5	V		
Reverse voltage	at I _R = 20 μA	V_R	4.5	-	-	V		
Reverse current	at V _R = 4.5 V	I _R	-	-	20	μA		
Reverse breakdown voltage	at I _R = 1 mA	V_{BR}	5.5	6.8	7.7	V		
Reverse clamping voltage	at I _{PP} = 1 A	V _C	-	7.5	9	V		
neverse clamping voltage	at I _{PP} = I _{PPM} = 30 A	VC	-	15.7	18.8	V		
0	at V _R = 0 V; f = 1 MHz	C _D	-	155	225	pF		
Capacitance	at $V_R = 2 V$; $f = 1 MHz$		ı	135	-	pF		

ELECTRICAL CHARACTERISTICS GSOT05C (T _{amb} = 25 °C unless otherwise specified) between pin 1 to pin 2 or pin 2 to pin1; pin 3 not connected								
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Protection paths	Number of lines which can be protected	N _{channel}	-	-	1	lines		
Reverse stand-off voltage	Max. reverse working voltage	V_{RWM}	-	-	5.5	V		
Reverse voltage	at I _R = 10 μA	V_R	5.5	-	-	V		
Reverse current	at V _R = 5.5 V	I _R	ı	-	10	μΑ		
Reverse breakdown voltage	at I _R = 1 mA	V_{BR}	6.5	7.5	8.7	V		
Reverse clamping voltage	at I _{PP} = 1 A	V _C	-	8.1	9.7	V		
heverse clamping voltage	at I _{PP} = I _{PPM} = 30 A	v _C	-	17	20.4	V		
Consolitores	at V _R = 0 V; f = 1 MHz	C _D	-	130	175	pF		
Capacitance	at $V_R = 4 V$; $f = 1 MHz$		-	100	-	pF		

ELECTRICAL CHARACTERISTICS GSOT08C (T _{amb} = 25 °C unless otherwise specified) between pin 1 to pin 2 or pin 2 to pin1; pin 3 not connected								
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Protection paths	Number of lines which can be protected	N _{channel}	-	-	1	lines		
Reverse stand-off voltage	Max. reverse working voltage	V_{RWM}	-	-	8.5	V		
Reverse voltage	at I _R = 5 μA	V_R	8.5	1	-	V		
Reverse current	at V _R = 8.5 V	I _R	ı	-	5	μA		
Reverse breakdown voltage	at I _R = 1 mA	V_{BR}	9.5	10.7	11.7	V		
Reverse clamping voltage	at I _{PP} = 1 A	V _C	ı	11.7	14	V		
neverse clamping voltage	at I _{PP} = I _{PPM} = 18 A	v _C	ı	18.5	22.2	V		
Canacitanas	at V _R = 0 V; f = 1 MHz	- C _D	-	80	125	pF		
Capacitance	at $V_R = 4 V$; $f = 1 MHz$		-	60	-	pF		

ELECTRICAL CHARACTERISTICS GSOT12C (T _{amb} = 25 °C unless otherwise specified) between pin 1 to pin 2 or pin 2 to pin1; pin 3 not connected									
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT			
Protection paths	Number of lines which can be protected	N _{channel}	-	-	1	lines			
Reverse stand-off voltage	Max. reverse working voltage	V_{RWM}	-	-	12.5	V			
Reverse voltage	at I _R = 1 μA	V_R	12.5	-	-	V			
Reverse current	at V _R = 12.5 V	I _R	-	-	1	μΑ			
Reverse breakdown voltage	at I _R = 1 mA	V_{BR}	13.5	15.7	16.5	V			
Reverse clamping voltage	at I _{PP} = 1 A	V	-	16.4	19.7	V			
neverse clamping voltage	at I _{PP} = I _{PPM} = 12 A	V _C	-	23.4	28.1	V			
Capacitance	at V _R = 0 V; f = 1 MHz	- C _D	-	58	75	pF			
	at V _R = 7.5 V; f = 1 MHz		ı	36	-	pF			

Rev. 2.9, 17-Apr-2019 9 Document Number: 85824



ELECTRICAL CHARACTERISTICS GSOT15C (T _{amb} = 25 °C unless otherwise specified) between pin 1 to pin 2 or pin 2 to pin1; pin 3 not connected								
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Protection paths	Number of lines which can be protected	N _{channel}	-	-	1	lines		
Reverse stand-off voltage	Max. reverse working voltage	V_{RWM}	-	-	15.5	V		
Reverse voltage	at I _R = 1 μA	V_R	15.5	-	-	V		
Reverse current	at V _R = 15.5 V	I _R	-	-	1	μΑ		
Reverse breakdown voltage	at I _R = 1 mA	V_{BR}	17	18.7	20.7	V		
Reverse clamping voltage	at I _{PP} = 1 A	V _C	i	20.4	24.5	V		
neverse clamping voltage	at I _{PP} = I _{PPM} = 8 A	VC	-	26.6	30.6	V		
Capacitance	at $V_R = 0 V$; $f = 1 MHz$	- C _D	-	45	60	pF		
Capacitance	at V _R = 7.5 V; f = 1 MHz		-	25	-	pF		

ELECTRICAL CHARACTERISTICS GSOT24C (T _{amb} = 25 °C unless otherwise specified) between pin 1 to pin 2 or pin 2 to pin1; pin 3 not connected									
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT			
Protection paths	Number of lines which can be protected	N _{channel}	-	-	1	lines			
Reverse stand-off voltage	Max. reverse working voltage	V_{RWM}	-	-	24.5	V			
Reverse voltage	at I _R = 1 μA	V_R	24.5	-	-	V			
Reverse current	at V _R = 24.5 V	I _R	-	-	1	μΑ			
Reverse breakdown voltage	at I _R = 1 mA	V_{BR}	27.5	30.7	33.7	V			
Reverse clamping voltage	at I _{PP} = 1 A	V _C	-	34	41	V			
	at I _{PP} = I _{PPM} = 5 A		-	40	48	V			
Capacitance	at V _R = 0 V; f = 1 MHz	- C _D	-	33	40	pF			
	at V _R = 12 V; f = 1 MHz		-	18	-	pF			

ELECTRICAL CHARACTERISTICS GSOT36C (T _{amb} = 25 °C unless otherwise specified) between pin 1 to pin 2 or pin 2 to pin1; pin 3 not connected									
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT			
Protection paths	Number of lines which can be protected	N _{channel}	-	-	1	lines			
Reverse stand-off voltage	Max. reverse working voltage	V_{RWM}	ı	ı	36.5	V			
Reverse voltage	at I _R = 1 μA	V_R	36.5	ı	-	V			
Reverse current	at V _R = 36.5 V	I _R	-	-	1	μΑ			
Reverse breakdown voltage	at I _R = 1 mA	V_{BR}	39.5	43.7	47.7	V			
Reverse clamping voltage	at I _{PP} = 1 A	V _C	-	50	60	V			
	at $I_{PP} = I_{PPM} = 3.5 \text{ A}$		ı	60	72	V			
Capacitance	at $V_R = 0 V$; $f = 1 MHz$	- C _D	-	26	33	pF			
	at V _R = 18 V; f = 1 MHz		-	10	-	pF			

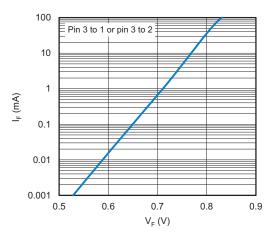


Fig. 1 - Typical Forward Current I_F vs. Forward Voltage V_F

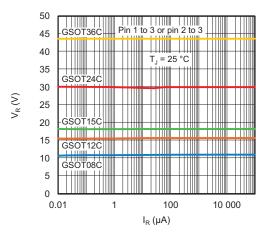


Fig. 2 - Typical Reverse Voltage V_R vs. Reverse Current I_R

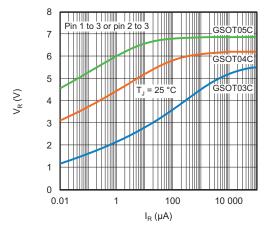


Fig. 3 - Typical Reverse Voltage V_{R} vs. Reverse Current I_{R}

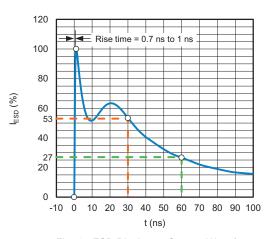


Fig. 4 - ESD Discharge Current Waveform According to IEC 61000-4-2 (330 $\Omega\,/$ 150 pF)

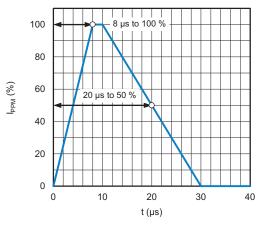


Fig. 5 - 8/20 µs Peak Pulse Current Waveform According to IEC 61000-4-5

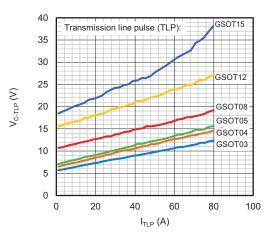


Fig. 6 - Typical Clamping Voltage vs. Peak Pulse Current

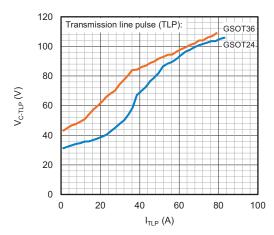


Fig. 7 - Typical Clamping Voltage vs. Peak Pulse Current

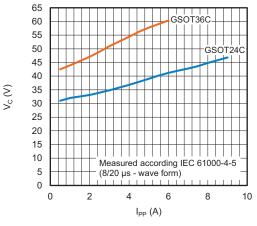


Fig. 9 - Typical Peak Clamping Voltage vs. Peak Pulse Current

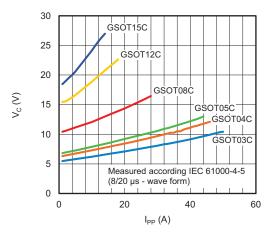


Fig. 8 - Typical Peak Clamping Voltage vs. Peak Pulse Current

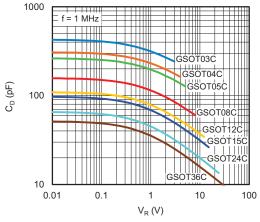
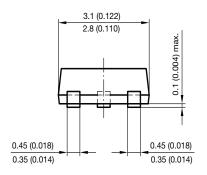
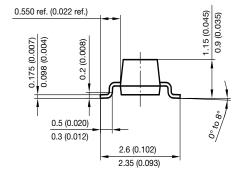
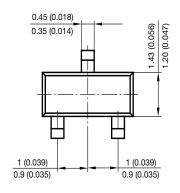


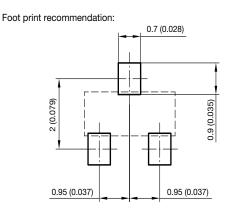
Fig. 10 - Typical Capacitance vs. Reverse Voltage

PACKAGE DIMENSIONS in millimeters (inches): SOT-23

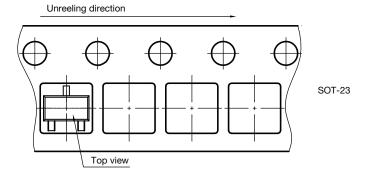








Document no.: 6.541-5014.01-4 Rev. 8 - Date: 23. Sep. 2009 17418



Orientation in carrier tape SOT-23 S8-V-3929.01-006 (4) 04.02.2010 22607

Legal Disclaimer Notice



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.